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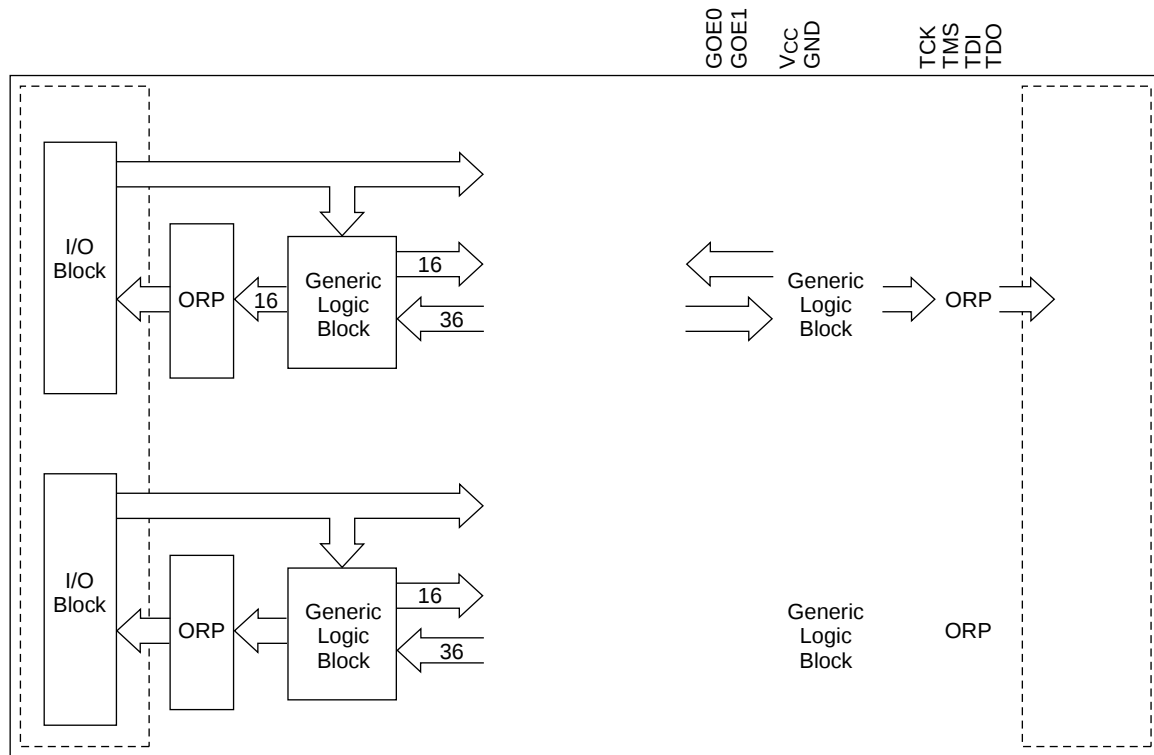
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	-
Number of I/O	30
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064v-75t44i

Figure 1. Functional Block Diagram

The I/Os in the ispMACH 4000 are split into two banks. Each bank has a separate I/O power supply. Inputs can support a variety of standards independent of the chip or bank power supply. Outputs support the standards compatible with the power supply provided to the bank. Support for a variety of standards helps designers implement designs in mixed voltage environments. In addition, 5V tolerant inputs are specified within an I/O bank that is connected to V_{CC0} of 3.0V to 3.6V for LVCMOS 3.3, LVTTTL and PCI interfaces.

ispMACH 4000 Architecture

There are a total of two GLBs in the ispMACH 4032, increasing to 32 GLBs in the ispMACH 4512. Each GLB has 36 inputs. All GLB inputs come from the GRP and all outputs from the GLB are brought back into the GRP to be connected to the inputs of any other GLB on the device. Even if feedback signals return to the same GLB, they still must go through the GRP. This mechanism ensures that GLBs communicate with each other with consistent and predictable delays. The outputs from the GLB are also sent to the ORP. The ORP then sends them to the associated I/O cells in the I/O block.

Generic Logic Block

The ispMACH 4000 GLB consists of a programmable AND array, logic allocator, 16 macrocells and a GLB clock generator. Macrocells are decoupled from the product terms through the logic allocator and the I/O pins are decoupled from macrocells through the ORP. Figure 2 illustrates the GLB.

- LVTTTL
- LVCMOS 3.3
- LVCMOS 2.5
- LVCMOS 1.8
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

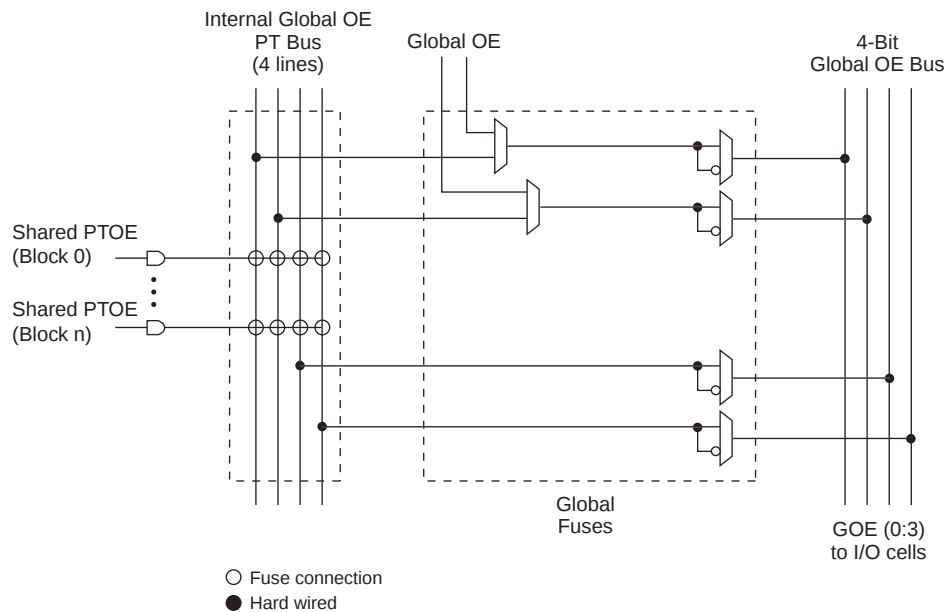
Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

Figure 9. Global OE Generation for All Devices Except ispMACH 4032



ispMACH 4000Z External Switching Characteristics (Cont.)

Over Recommended Operating Conditions

Parameter	Description ^{1, 2, 3}	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{PD}	5-PT bypass combinatorial propagation delay	—	4.5	—	5.0	—	7.5	ns
t _{PD_MC}	20-PT combinatorial propagation delay through macrocell	—	5.8	—	6.0	—	8.0	ns
t _S	GLB register setup time before clock	2.9	—	3.0	—	4.5	—	ns
t _{ST}	GLB register setup time before clock with T-type register	3.1	—	3.2	—	4.7	—	ns
t _{SIR}	GLB register setup time before clock, input register path	1.3	—	1.3	—	1.4	—	ns
t _{SIRZ}	GLB register setup time before clock with zero hold	2.6	—	2.6	—	2.7	—	ns
t _H	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t _{HT}	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t _{HIR}	GLB register hold time after clock, input register path	1.3	—	1.3	—	1.3	—	ns
t _{HIRZ}	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t _{CO}	GLB register clock-to-output delay	—	3.8	—	4.2	—	4.5	ns
t _R	External reset pin to output delay	—	7.5	—	7.5	—	9.0	ns
t _{RW}	External reset pulse duration	2.0	—	2.0	—	4.0	—	ns
t _{PTOE/DIS}	Input to output local product term output enable/disable	—	8.2	—	8.5	—	9.0	ns
t _{GPTOE/DIS}	Input to output global product term output enable/disable	—	10.0	—	10.0	—	10.5	ns
t _{GOE/DIS}	Global OE input to output enable/disable	—	5.5	—	6.0	—	7.0	ns
t _{CW}	Global clock width, high or low	1.8	—	2.0	—	2.8	—	ns
t _{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.0	—	2.8	—	ns
t _{WIR}	Input register clock width, high or low	1.8	—	2.0	—	2.8	—	ns
f _{MAX} ⁴	Clock frequency with internal feedback	—	200	—	200	—	168	MHz
f _{MAX} (Ext.)	clock frequency with external feedback, [1 / (t _S + t _{CO})]	—	150	—	139	—	111	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C Internal Timing Parameters (Cont.)**Over Recommended Operating Conditions**

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{GPTOE}	Global PT OE Delay	—	5.58	—	5.58	—	5.78	ns
t _{PTOE}	Macrocell PT OE Delay	—	3.58	—	4.28	—	4.28	ns

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

ispMACH 4000V/B/C Timing Adders¹ (Cont.)

Adder Type	Base Parameter	Description	-5		-75		-10		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Delay Adders									
t _{INDIO}	t _{INREG}	Input register delay	—	1.00	—	1.00	—	1.00	ns
t _{EXP}	t _{MCELL}	Product term expander delay	—	0.33	—	0.33	—	0.33	ns
t _{ORP}	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	ns
t _{BLA}	t _{ROUTE}	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
t _{IOI} Input Adjusters									
LVTTL_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
t _{IOO} Output Adjusters									
LVTTL_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t _{BUF} , t _{EN}	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000Z Timing Adders ¹

Adder Type	Base Parameter	Description	-35		-37		-42		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Delay Adders									
t _{INDIO}	t _{INREG}	Input register delay	—	1.00	—	1.00	—	1.30	ns
t _{EXP}	t _{MCELL}	Product term expander delay	—	0.40	—	0.40	—	0.45	ns
t _{ORP}	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t _{BLA}	t _{ROUTE}	Additional block load-ing adder	—	0.04	—	0.05	—	0.05	ns
t _{IOI} Input Adjusters									
LVTTTL_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t _{IN} , t _{GCLK_IN} , t _{GOE}	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
t _{IOO} Output Adjusters									
LVTTTL_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t _{BUF} , t _{EN} , t _{DIS}	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t _{BUF} , t _{EN}	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding the use of these adders.

ispMACH 4000V/B/C/Z Power Supply and NC Connections¹

Signal	44-pin TQFP ²	48-pin TQFP ²	56-ball csBGA ³	100-pin TQFP ²	128-pin TQFP ²
VCC	11, 33	12, 36	K2, A9	25, 40, 75, 90	32, 51, 96, 115
VCCO0 VCCO (Bank 0)	6	6	F3	13, 33, 95	3, 17, 30, 41, 122
VCCO1 VCCO (Bank 1)	28	30	E8	45, 63, 83	58, 67, 81, 94, 105
GND	12, 34	13, 37	H3, C8	1, 26, 51, 76	1, 33, 65, 97
GND (Bank 0)	5	5	D3	7, 18, 32, 96	10, 24, 40, 113, 123
GND (Bank 1)	27	29	G8	46, 57, 68, 82	49, 59, 74, 88, 104
NC	—	—	4032Z: A8, B10, E1, E3, F8, F10, J1, K3	—	—

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:
44-Pin TQFP**

Pin Number	Bank Number	ispMACH 4032V/B/C		ispMACH 4064V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	TDI	-	TDI	-
2	0	A5	A^5	A10	A^5
3	0	A6	A^6	A12	A^6
4	0	A7	A^7	A14	A^7
5	0	GND (Bank 0)	-	GND (Bank 0)	-
6	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
7	0	A8	A^8	B0	B^0
8	0	A9	A^9	B2	B^1
9	0	A10	A^10	B4	B^2
10	-	TCK	-	TCK	-
11	-	VCC	-	VCC	-
12	-	GND	-	GND	-
13	0	A12	A^12	B8	B^4
14	0	A13	A^13	B10	B^5
15	0	A14	A^14	B12	B^6
16	0	A15	A^15	B14	B^7
17	1	CLK2/I	-	CLK2/I	-
18	1	B0	B^0	C0	C^0
19	1	B1	B^1	C2	C^1
20	1	B2	B^2	C4	C^2
21	1	B3	B^3	C6	C^3
22	1	B4	B^4	C8	C^4
23	-	TMS	-	TMS	-
24	1	B5	B^5	C10	C^5
25	1	B6	B^6	C12	C^6
26	1	B7	B^7	C14	C^7
27	1	GND (Bank 1)	-	GND (Bank 1)	-
28	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
29	1	B8	B^8	D0	D^0
30	1	B9	B^9	D2	D^1
31	1	B10	B^10	D4	D^2
32	-	TDO	-	TDO	-
33	-	VCC	-	VCC	-
34	-	GND	-	GND	-
35	1	B12	B^12	D8	D^4
36	1	B13	B^13	D10	D^5
37	1	B14	B^14	D12	D^6
38	1	B15/GOE1	B^15	D14/GOE1	D^7
39	0	CLK0/I	-	CLK0/I	-
40	0	A0/GOE0	A^0	A0/GOE0	A^0
41	0	A1	A^1	A2	A^1

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:
48-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
33	1	B10	B ¹⁰	D4	D ²	D10	D ⁵
34	1	B11	B ¹¹	D6	D ³	D8	D ⁴
35	-	TDO	-	TDO	-	TDO	-
36	-	VCC	-	VCC	-	VCC	-
37	-	GND	-	GND	-	GND	-
38	1	B12	B ¹²	D8	D ⁴	D6	D ³
39	1	B13	B ¹³	D10	D ⁵	D4	D ²
40	1	B14	B ¹⁴	D12	D ⁶	D2	D ¹
41	1	B15/GOE1	B ¹⁵	D14/GOE1	D ⁷	D0/GOE1	D ⁰
42	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
43	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
44	0	A0/GOE0	A ⁰	A0/GOE0	A ⁰	A0/GOE0	A ⁰
45	0	A1	A ¹	A2	A ¹	A1	A ¹
46	0	A2	A ²	A4	A ²	A2	A ²
47	0	A3	A ³	A6	A ³	A4	A ³
48	0	A4	A ⁴	A8	A ⁴	A6	A ⁴

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	TDI	-	TDI	-
C3	0	A5	A ⁵	A8	A ⁵
C1	0	A6	A ⁶	A10	A ⁶
D1	0	A7	A ⁷	A11	A ⁷
D3	0	GND (Bank 0)	-	GND (Bank 0)	-
E3	0	NC ¹	-	I ¹	-
E1	0	NC ¹	-	I ¹	-
F3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
F1	0	A8	A ⁸	B15	B ⁷
G3	0	A9	A ⁹	B12	B ⁶
G1	0	A10	A ¹⁰	B10	B ⁵
H1	0	A11	A ¹¹	B8	B ⁴
J1	0	NC	-	I	-
K1	-	TCK	-	TCK	-
K2	-	VCC	-	VCC	-
H3	-	GND	-	GND	-
K3	-	NC ¹	-	I ¹	-
K4	0	A12	A ¹²	B6	B ³
H4	0	A13	A ¹³	B4	B ²
H5	0	A14	A ¹⁴	B2	B ¹

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A ¹⁵	B0	B ⁰
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B ⁰	C0	C ⁰
K7	1	B1	B ¹	C1	C ¹
K8	1	B2	B ²	C2	C ²
K9	1	B3	B ³	C4	C ³
K10	1	B4	B ⁴	C6	C ⁴
J10	-	TMS	-	TMS	-
H8	1	B5	B ⁵	C8	C ⁵
H10	1	B6	B ⁶	C10	C ⁶
G10	1	B7	B ⁷	C11	C ⁷
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC ¹	-	I ¹	-
F10	1	NC ¹	-	I ¹	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B ⁸	D15	D ⁷
D8	1	B9	B ⁹	D12	D ⁶
D10	1	B10	B ¹⁰	D10	D ⁵
C10	1	B11	B ¹¹	D8	D ⁴
B10	1	NC ¹	-	I ¹	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC ¹	-	I ¹	-
A7	1	B12	B ¹²	D6	D ³
C7	1	B13	B ¹³	D4	D ²
C6	1	B14	B ¹⁴	D2	D ¹
A6	1	B15/GOE1	B ¹⁵	D0/GOE1	D ⁰
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A ⁰	A0/GOE0	A ⁰
A4	0	A1	A ¹	A1	A ¹
A3	0	A2	A ²	A2	A ²
A2	0	A3	A ³	A4	A ³
A1	0	A4	A ⁴	A6	A ⁴

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	GND	-	GND	-	GND	-
2	-	TDI	-	TDI	-	TDI	-
3	0	A8	A^8	B0	B^0	C12	C^3
4	0	A9	A^9	B2	B^1	C10	C^2
5	0	A10	A^10	B4	B^2	C6	C^1
6	0	A11	A^11	B6	B^3	C2	C^0
7	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
8	0	A12	A^12	B8	B^4	D12	D^3
9	0	A13	A^13	B10	B^5	D10	D^2
10	0	A14	A^14	B12	B^6	D6	D^1
11	0	A15	A^15	B13	B^7	D4	D^0
12*	0	I	-	I	-	I	-
13	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
14	0	B15	B^15	C14	C^7	E4	E^0
15	0	B14	B^14	C12	C^6	E6	E^1
16	0	B13	B^13	C10	C^5	E10	E^2
17	0	B12	B^12	C8	C^4	E12	E^3
18	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
19	0	B11	B^11	C6	C^3	F2	F^0
20	0	B10	B^10	C5	C^2	F6	F^1
21	0	B9	B^9	C4	C^1	F10	F^2
22	0	B8	B^8	C2	C^0	F12	F^3
23*	0	I	-	I	-	I	-
24	-	TCK	-	TCK	-	TCK	-
25	-	VCC	-	VCC	-	VCC	-
26	-	GND	-	GND	-	GND	-
27*	0	I	-	I	-	I	-
28	0	B7	B^7	D13	D^7	G12	G^3
29	0	B6	B^6	D12	D^6	G10	G^2
30	0	B5	B^5	D10	D^5	G6	G^1
31	0	B4	B^4	D8	D^4	G2	G^0
32	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
33	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
34	0	B3	B^3	D6	D^3	H12	H^3
35	0	B2	B^2	D4	D^2	H10	H^2
36	0	B1	B^1	D2	D^1	H6	H^1
37	0	B0	B^0	D0	D^0	H2	H^0
38	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
39	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
40	-	VCC	-	VCC	-	VCC	-
41	1	C0	C^0	E0	E^0	I2	I^0

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	1	C1	C^1	E2	E^1	I6	I^1
43	1	C2	C^2	E4	E^2	I10	I^2
44	1	C3	C^3	E6	E^3	I12	I^3
45	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
46	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
47	1	C4	C^4	E8	E^4	J2	J^0
48	1	C5	C^5	E10	E^5	J6	J^1
49	1	C6	C^6	E12	E^6	J10	J^2
50	1	C7	C^7	E14	E^7	J12	J^3
51	-	GND	-	GND	-	GND	-
52	-	TMS	-	TMS	-	TMS	-
53	1	C8	C^8	F0	F^0	K12	K^3
54	1	C9	C^9	F2	F^1	K10	K^2
55	1	C10	C^10	F4	F^2	K6	K^1
56	1	C11	C^11	F6	F^3	K2	K^0
57	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
58	1	C12	C^12	F8	F^4	L12	L^3
59	1	C13	C^13	F10	F^5	L10	L^2
60	1	C14	C^14	F12	F^6	L6	L^1
61	1	C15	C^15	F13	F^7	L4	L^0
62*	1	I	-	I	-	I	-
63	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
64	1	D15	D^15	G14	G^7	M4	M^0
65	1	D14	D^14	G12	G^6	M6	M^1
66	1	D13	D^13	G10	G^5	M10	M^2
67	1	D12	D^12	G8	G^4	M12	M^3
68	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
69	1	D11	D^11	G6	G^3	N2	N^0
70	1	D10	D^10	G5	G^2	N6	N^1
71	1	D9	D^9	G4	G^1	N10	N^2
72	1	D8	D^8	G2	G^0	N12	N^3
73*	1	I	-	I	-	I	-
74	-	TDO	-	TDO	-	TDO	-
75	-	VCC	-	VCC	-	VCC	-
76	-	GND	-	GND	-	GND	-
77*	1	I	-	I	-	I	-
78	1	D7	D^7	H13	H^7	O12	O^3
79	1	D6	D^6	H12	H^6	O10	O^2
80	1	D5	D^5	H10	H^5	O6	O^1
81	1	D4	D^4	H8	H^4	O2	O^0
82	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-

ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	GND	-	GND	-
2	-	TDI	-	TDI	-
3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
4	0	B0	B ⁰	C12	C ⁶
5	0	B1	B ¹	C10	C ⁵
6	0	B2	B ²	C8	C ⁴
7	0	B4	B ³	C6	C ³
8	0	B5	B ⁴	C4	C ²
9	0	B6	B ⁵	C2	C ¹
10	0	GND (Bank 0)	-	GND (Bank 0)	-
11	0	B8	B ⁶	D14	D ⁷
12	0	B9	B ⁷	D12	D ⁶
13	0	B10	B ⁸	D10	D ⁵
14	0	B12	B ⁹	D8	D ⁴
15	0	B13	B ¹⁰	D6	D ³
16	0	B14	B ¹¹	D4	D ²
17	-	NC ²	-	I ²	-
18	0	GND (Bank 0) ¹	-	NC ¹	-
19	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
20	0	NC ²	-	I ²	-
21	0	C14	C ¹¹	E2	E ¹
22	0	C13	C ¹⁰	E4	E ²
23	0	C12	C ⁹	E6	E ³
24	0	C10	C ⁸	E8	E ⁴
25	0	C9	C ⁷	E10	E ⁵
26	0	C8	C ⁶	E12	E ⁶
27	0	GND (Bank 0)	-	GND (Bank 0)	-
28	0	C6	C ⁵	F2	F ¹
29	0	C5	C ⁴	F4	F ²
30	0	C4	C ³	F6	F ³
31	0	C2	C ²	F8	F ⁴
32	0	C1	C ¹	F10	F ⁵
33	0	C0	C ⁰	F12	F ⁶
34	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
35	-	TCK	-	TCK	-
36	-	VCC	-	VCC	-
37	-	GND	-	GND	-
38	0	NC ²	-	I ²	-
39	0	D14	D ¹¹	G12	G ⁶
40	0	D13	D ¹⁰	G10	G ⁵
41	0	D12	D ⁹	G8	G ⁴
42	0	D10	D ⁸	G6	G ³

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
19	0	D4	D ²	E4	E ²	G4	G ²
20	0	D2	D ¹	E2	E ¹	G2	G ¹
21	0	D0	D ⁰	E0	E ⁰	G0	G ⁰
22	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
23	0	E0	E ⁰	H0	H ⁰	J0	J ⁰
24	0	E2	E ¹	H2	H ¹	J2	J ¹
25	0	E4	E ²	H4	H ²	J4	J ²
26	0	E6	E ³	H6	H ³	J6	J ³
27	0	E8	E ⁴	H8	H ⁴	J8	J ⁴
28	0	E10	E ⁵	H10	H ⁵	J10	J ⁵
29	0	E12	E ⁶	H12	H ⁶	J12	J ⁶
30	0	E14	E ⁷	H14	H ⁷	J14	J ⁷
31	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
32	0	F0	F ⁰	J0	J ⁰	N0	N ⁰
33	0	F2	F ¹	J2	J ¹	N2	N ¹
34	0	F4	F ²	J4	J ²	N4	N ²
35	0	F6	F ³	J6	J ³	N6	N ³
36	0	F8	F ⁴	J8	J ⁴	N8	N ⁴
37	0	F10	F ⁵	J10	J ⁵	N10	N ⁵
38	0	F12	F ⁶	J12	J ⁶	N12	N ⁶
39	0	F14	F ⁷	J14	J ⁷	N14	N ⁷
40	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
41	-	TCK	-	TCK	-	TCK	-
42	-	VCC	-	VCC	-	VCC	-
43	-	NC	-	NC	-	NC	-
44	-	NC	-	NC	-	NC	-
45	-	NC	-	NC	-	NC	-
46	-	GND	-	GND (Bank 0)	-	GND	-
47	0	G14	G ⁷	K14	K ⁷	O14	O ⁷
48	0	G12	G ⁶	K12	K ⁶	O12	O ⁶
49	0	G10	G ⁵	K10	K ⁵	O10	O ⁵
50	0	G8	G ⁴	K8	K ⁴	O8	O ⁴
51	0	G6	G ³	K6	K ³	O6	O ³
52	0	G4	G ²	K4	K ²	O4	O ²
53	0	G2	G ¹	K2	K ¹	O2	O ¹
54	0	G0	G ⁰	K0	K ⁰	O0	O ⁰
55	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
56	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
57	0	H14	H ⁷	L14	L ⁷	P14	P ⁷
58	0	H12	H ⁶	L12	L ⁶	P12	P ⁶
59	0	H10	H ⁵	L10	L ⁵	P10	P ⁵

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
101	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
102	1	L14	L ¹⁴	AX14	AX ¹⁴	GX14	GX ¹⁴
103	1	L12	L ¹²	AX12	AX ¹²	GX12	GX ¹²
104	1	L10	L ¹⁰	AX10	AX ¹⁰	GX10	GX ¹⁰
105	1	L8	L ⁸	AX8	AX ⁸	GX8	GX ⁸
106	1	L6	L ⁶	AX6	AX ⁶	GX6	GX ⁶
107	1	L4	L ⁴	AX4	AX ⁴	GX4	GX ⁴
108	1	L2	L ²	AX2	AX ²	GX2	GX ²
109	1	L0	L ⁰	AX0	AX ⁰	GX0	GX ⁰
110	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
111	1	M0	M ⁰	DX0	DX ⁰	JX0	JX ⁰
112	1	M2	M ²	DX2	DX ²	JX2	JX ²
113	1	M4	M ⁴	DX4	DX ⁴	JX4	JX ⁴
114	1	M6	M ⁶	DX6	DX ⁶	JX6	JX ⁶
115	1	M8	M ⁸	DX8	DX ⁸	JX8	JX ⁸
116	1	M10	M ¹⁰	DX10	DX ¹⁰	JX10	JX ¹⁰
117	1	M12	M ¹²	DX12	DX ¹²	JX12	JX ¹²
118	1	M14	M ¹⁴	DX14	DX ¹⁴	JX14	JX ¹⁴
119	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
120	1	N0	N ⁰	FX0	FX ⁰	NX0	NX ⁰
121	1	N2	N ²	FX2	FX ²	NX2	NX ²
122	1	N4	N ⁴	FX4	FX ⁴	NX4	NX ⁴
123	1	N6	N ⁶	FX6	FX ⁶	NX6	NX ⁶
124	1	N8	N ⁸	FX8	FX ⁸	NX8	NX ⁸
125	1	N10	N ¹⁰	FX10	FX ¹⁰	NX10	NX ¹⁰
126	1	N12	N ¹²	FX12	FX ¹²	NX12	NX ¹²
127	1	N14	N ¹⁴	FX14	FX ¹⁴	NX14	NX ¹⁴
128	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
129	-	TDO	-	TDO	-	TDO	-
130	-	VCC	-	VCC	-	VCC	-
131	-	NC	-	NC	-	NC	-
132	-	NC	-	NC	-	NC	-
133	-	NC	-	NC	-	NC	-
134	-	GND	-	GND	-	GND	-
135	1	O14	O ¹⁴	GX14	GX ¹⁴	OX14	OX ¹⁴
136	1	O12	O ¹²	GX12	GX ¹²	OX12	OX ¹²
137	1	O10	O ¹⁰	GX10	GX ¹⁰	OX10	OX ¹⁰
138	1	O8	O ⁸	GX8	GX ⁸	OX8	OX ⁸
139	1	O6	O ⁶	GX6	GX ⁶	OX6	OX ⁶
140	1	O4	O ⁴	GX4	GX ⁴	OX4	OX ⁴
141	1	O2	O ²	GX2	GX ²	OX2	OX ²

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

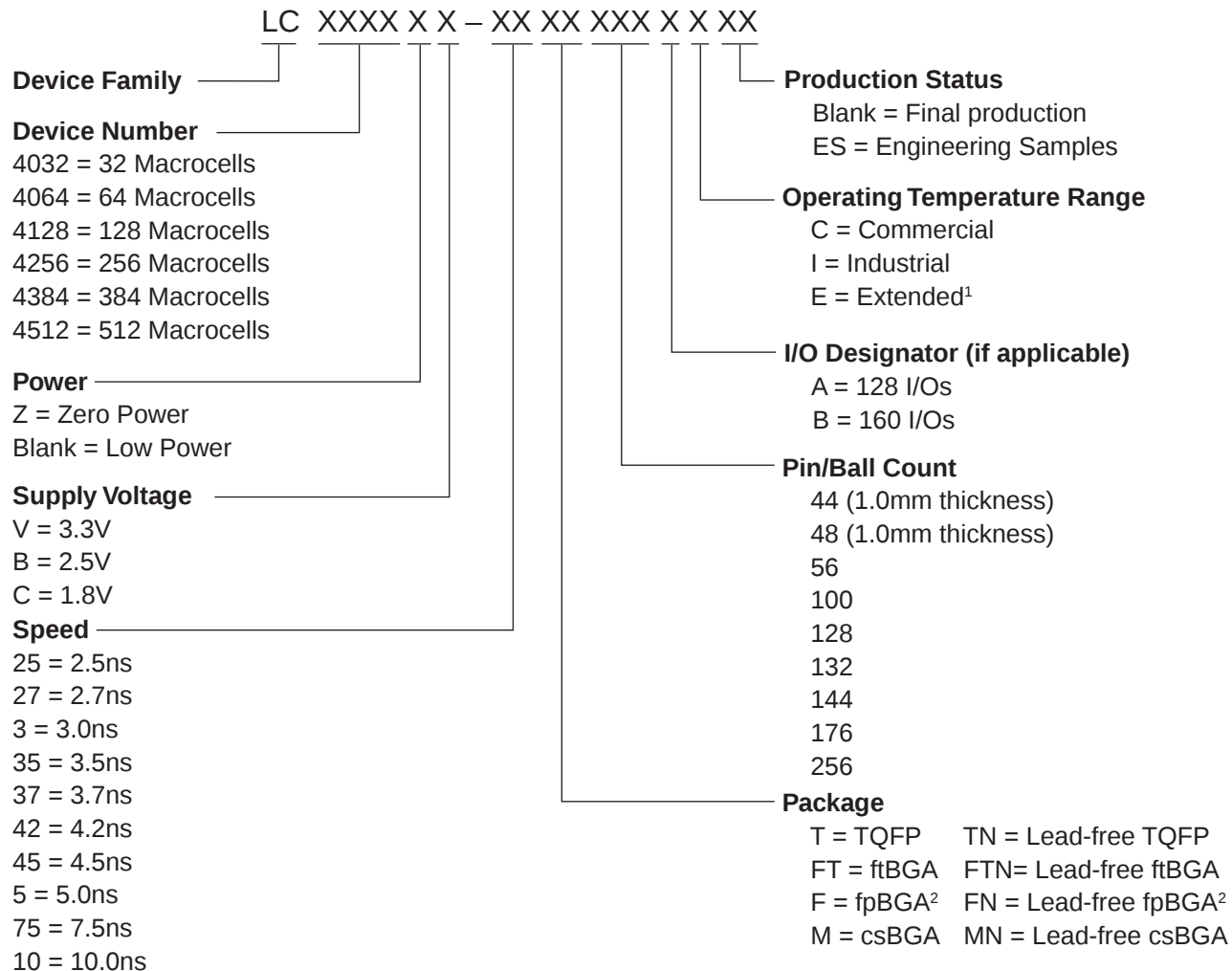
Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
R5	0	NC	-	NC	-	NC	-	L4	L [^] 1
T5	0	NC	-	NC	-	I2	I [^] 1	L8	L [^] 2
R6	0	NC	-	NC	-	I0	I [^] 0	L12	L [^] 3
T6	0	NC	-	H14	H [^] 9	G12	G [^] 6	M8	M [^] 2
N7	0	NC	-	H12	H [^] 8	G14	G [^] 7	M12	M [^] 3
P7	0	H14	H [^] 7	H10	H [^] 7	L14	L [^] 7	P14	P [^] 7
R7	0	H12	H [^] 6	H9	H [^] 6	L12	L [^] 6	P12	P [^] 6
L8	0	H10	H [^] 5	H8	H [^] 5	L10	L [^] 5	P10	P [^] 5
T7	0	H8	H [^] 4	H6	H [^] 4	L8	L [^] 4	P8	P [^] 4
M8	0	H6	H [^] 3	H4	H [^] 3	L6	L [^] 3	P6	P [^] 3
N8	0	H4	H [^] 2	H2	H [^] 2	L4	L [^] 2	P4	P [^] 2
R8	0	H2	H [^] 1	H1	H [^] 1	L2	L [^] 1	P2	P [^] 1
P8	0	H0	H [^] 0	H0	H [^] 0	L0	L [^] 0	P0	P [^] 0
-	-	GND	-	GND	-	GND	-	GND	-
T8	0	CLK1/I	-	CLK1/I	-	CLK1/I	-	CLK1/I	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
N9	1	CLK2/I	-	CLK2/I	-	CLK2/I	-	CLK2/I	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
P9	1	I0	I [^] 0	I0	I [^] 0	M0	M [^] 0	AX0	AX [^] 0
R9	1	I2	I [^] 1	I1	I [^] 1	M2	M [^] 1	AX2	AX [^] 1
T9	1	I4	I [^] 2	I2	I [^] 2	M4	M [^] 2	AX4	AX [^] 2
T10	1	I6	I [^] 3	I4	I [^] 3	M6	M [^] 3	AX6	AX [^] 3
R10	1	I8	I [^] 4	I6	I [^] 4	M8	M [^] 4	AX8	AX [^] 4
M9	1	I10	I [^] 5	I8	I [^] 5	M10	M [^] 5	AX10	AX [^] 5
P10	1	I12	I [^] 6	I9	I [^] 6	M12	M [^] 6	AX12	AX [^] 6
L9	1	I14	I [^] 7	I10	I [^] 7	M14	M [^] 7	AX14	AX [^] 7
N10	1	NC	-	I12	I [^] 8	BX14	BX [^] 7	DX0	DX [^] 0
T11	1	NC	-	I14	I [^] 9	BX12	BX [^] 6	DX4	DX [^] 1
R11	1	NC	-	NC	-	P0	P [^] 0	EX0	EX [^] 0
T12	1	NC	-	NC	-	P2	P [^] 1	EX4	EX [^] 1
N12	1	NC	-	NC	-	NC	-	EX8	EX [^] 2
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
R12	1	NC	-	NC	-	NC	-	EX12	EX [^] 3
T13	1	NC	-	J0	J [^] 0	BX10	BX [^] 5	DX8	DX [^] 2
P12	1	NC	-	J1	J [^] 1	BX8	BX [^] 4	DX12	DX [^] 3
M10	1	J0	J [^] 0	J2	J [^] 2	N0	N [^] 0	BX0	BX [^] 0
R13	1	J2	J [^] 1	J4	J [^] 3	N2	N [^] 1	BX2	BX [^] 1
L10	1	J4	J [^] 2	J6	J [^] 4	N4	N [^] 2	BX4	BX [^] 2
T14	1	J6	J [^] 3	J8	J [^] 5	N6	N [^] 3	BX6	BX [^] 3
M11	1	J8	J [^] 4	J9	J [^] 6	N8	N [^] 4	BX8	BX [^] 4

ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections: 256-Ball ftBGA/fpBGA (Cont.)

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
E7	0	NC	-	B1	B ¹	F8	F ⁴	D12	D ³
A3	0	B0	B ⁰	B2	B ²	B0	B ⁰	B0	B ⁰
F7	0	B2	B ¹	B4	B ³	B2	B ¹	B2	B ¹
B4	0	B4	B ²	B6	B ⁴	B4	B ²	B4	B ²
C5	0	B6	B ³	B8	B ⁵	B6	B ³	B6	B ³
A2	0	B8	B ⁴	B9	B ⁶	B8	B ⁴	B8	B ⁴
E6	0	B10	B ⁵	B10	B ⁷	B10	B ⁵	B10	B ⁵
B3	0	B12	B ⁶	B12	B ⁸	B12	B ⁶	B12	B ⁶
C4	0	B14	B ⁷	B14	B ⁹	B14	B ⁷	B14	B ⁷
D4	0	NC	-	NC	-	D10	D ⁵	F0	F ⁰
E5	0	NC	-	NC	-	D8	D ⁴	F2	F ¹
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	-	-	-	-	GND	-	GND	-
-	0	-	-	-	-	GND (Bank 0)	-	GND (Bank 0)	-

Note: VCC, VCCO and GND are tied together to their respective common signal on the package substrate. See Power Supply and NC Connections table for VCC/ VCCO/GND pin definitions.

Part Number Description



1. For automotive AEC-Q100 compliant devices, refer to the LA-ispMACH 4000V/Z Automotive Family Data Sheet (DS1017).

2. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000 Family Speed Grade Offering

	-25	-27	-3	-35	-37	-42	-45	-5		-75			-10
	Com	Com	Com	Com	Com	Com	Com	Com	Ind	Com	Ind	Ext	Ind
ispMACH 4032V/B/C												1	
ispMACH 4064V/B/C												1	
ispMACH 4128V/B/C												1	
ispMACH 4256V/B/C													
ispMACH 4384V/B/C													
ispMACH 4512V/B/C													
ispMACH 4032ZC												1	
ispMACH 4064ZC												1	
ispMACH 4128ZC												1	
ispMACH 4256ZC													

1. 3.3V only.

ispMACH 4000V (3.3V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-3FTN256AC	256	3.3	3	Lead-free ftBGA	256	128	C
	LC4256V-5FTN256AC	256	3.3	5	Lead-free ftBGA	256	128	C
	LC4256V-75FTN256AC	256	3.3	7.5	Lead-free ftBGA	256	128	C
	LC4256V-3FTN256BC	256	3.3	3	Lead-free ftBGA	256	160	C
	LC4256V-5FTN256BC	256	3.3	5	Lead-free ftBGA	256	160	C
	LC4256V-75FTN256BC	256	3.3	7.5	Lead-free ftBGA	256	160	C
	LC4256V-3FN256AC ¹	256	3.3	3	Lead-free fpBGA	256	128	C
	LC4256V-5FN256AC ¹	256	3.3	5	Lead-free fpBGA	256	128	C
	LC4256V-75FN256AC ¹	256	3.3	7.5	Lead-free fpBGA	256	128	C
	LC4256V-3FN256BC ¹	256	3.3	3	Lead-free fpBGA	256	160	C
	LC4256V-5FN256BC ¹	256	3.3	5	Lead-free fpBGA	256	160	C
	LC4256V-75FN256BC ¹	256	3.3	7.5	Lead-free fpBGA	256	160	C
	LC4256V-3TN176C	256	3.3	3	Lead-free TQFP	176	128	C
	LC4256V-5TN176C	256	3.3	5	Lead-free TQFP	176	128	C
	LC4256V-75TN176C	256	3.3	7.5	Lead-free TQFP	176	128	C
	LC4256V-3TN144C	256	3.3	3	Lead-free TQFP	144	96	C
	LC4256V-5TN144C	256	3.3	5	Lead-free TQFP	144	96	C
	LC4256V-75TN144C	256	3.3	7.5	Lead-free TQFP	144	96	C
	LC4256V-3TN100C	256	3.3	3	Lead-free TQFP	100	64	C
	LC4256V-5TN100C	256	3.3	5	Lead-free TQFP	100	64	C
	LC4256V-75TN100C	256	3.3	7.5	Lead-free TQFP	100	64	C
LC4384V	LC4384V-35FTN256C	384	3.3	3.5	Lead-free ftBGA	256	192	C
	LC4384V-5FTN256C	384	3.3	5	Lead-free ftBGA	256	192	C
	LC4384V-75FTN256C	384	3.3	7.5	Lead-free ftBGA	256	192	C
	LC4384V-35FN256C ¹	384	3.3	3.5	Lead-free fpBGA	256	192	C
	LC4384V-5FN256C ¹	384	3.3	5	Lead-free fpBGA	256	192	C
	LC4384V-75FN256C ¹	384	3.3	7.5	Lead-free fpBGA	256	192	C
	LC4384V-35TN176C	384	3.3	3.5	Lead-free TQFP	176	128	C
	LC4384V-5TN176C	384	3.3	5	Lead-free TQFP	176	128	C
	LC4384V-75TN176C	384	3.3	7.5	Lead-free TQFP	176	128	C
LC4512V	LC4512V-35FTN256C	512	3.3	3.5	Lead-free ftBGA	256	208	C
	LC4512V-5FTN256C	512	3.3	5	Lead-free ftBGA	256	208	C
	LC4512V-75FTN256C	512	3.3	7.5	Lead-free ftBGA	256	208	C
	LC4512V-35FN256C ¹	512	3.3	3.5	Lead-free fpBGA	256	208	C
	LC4512V-5FN256C ¹	512	3.3	5	Lead-free fpBGA	256	208	C
	LC4512V-75FN256C ¹	512	3.3	7.5	Lead-free fpBGA	256	208	C
	LC4512V-35TN176C	512	3.3	3.5	Lead-free TQFP	176	128	C
	LC4512V-5TN176C	512	3.3	5	Lead-free TQFP	176	128	C
	LC4512V-75TN176C	512	3.3	7.5	Lead-free TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Industrial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-5FTN256AI	256	3.3	5	Lead-free ftBGA	256	128	I
	LC4256V-75FTN256AI	256	3.3	7.5	Lead-free ftBGA	256	128	I
	LC4256V-10FTN256AI	256	3.3	10	Lead-free ftBGA	256	128	I
	LC4256V-5FTN256BI	256	3.3	5	Lead-free ftBGA	256	160	I
	LC4256V-75FTN256BI	256	3.3	7.5	Lead-free ftBGA	256	160	I
	LC4256V-10FTN256BI	256	3.3	10	Lead-free ftBGA	256	160	I
	LC4256V-5FN256AI ¹	256	3.3	5	Lead-free fpBGA	256	128	I
	LC4256V-75FN256AI ¹	256	3.3	7.5	Lead-free fpBGA	256	128	I
	LC4256V-10FN256AI ¹	256	3.3	10	Lead-free fpBGA	256	128	I
	LC4256V-5FN256BI ¹	256	3.3	5	Lead-free fpBGA	256	160	I
	LC4256V-75FN256BI ¹	256	3.3	7.5	Lead-free fpBGA	256	160	I
	LC4256V-10FN256BI ¹	256	3.3	10	Lead-free fpBGA	256	160	I
	LC4256V-5TN176I	256	3.3	5	Lead-free TQFP	176	128	I
	LC4256V-75TN176I	256	3.3	7.5	Lead-free TQFP	176	128	I
	LC4256V-10TN176I	256	3.3	10	Lead-free TQFP	176	128	I
	LC4256V-5TN144I	256	3.3	5	Lead-free TQFP	144	96	I
	LC4256V-75TN144I	256	3.3	7.5	Lead-free TQFP	144	96	I
	LC4256V-10TN144I	256	3.3	10	Lead-free TQFP	144	96	I
	LC4256V-5TN100I	256	3.3	5	Lead-free TQFP	100	64	I
	LC4256V-75TN100I	256	3.3	7.5	Lead-free TQFP	100	64	I
	LC4256V-10TN100I	256	3.3	10	Lead-free TQFP	100	64	I
LC4384V	LC4384V-5FTN256I	384	3.3	5	Lead-free ftBGA	256	192	I
	LC4384V-75FTN256I	384	3.3	7.5	Lead-free ftBGA	256	192	I
	LC4384V-10FTN256I	384	3.3	10	Lead-free ftBGA	256	192	I
	LC4384V-5FN256I ¹	384	3.3	5	Lead-free fpBGA	256	192	I
	LC4384V-75FN256I ¹	384	3.3	7.5	Lead-free fpBGA	256	192	I
	LC4384V-10FN256I ¹	384	3.3	10	Lead-free fpBGA	256	192	I
	LC4384V-5TN176I	384	3.3	5	Lead-free TQFP	176	128	I
	LC4384V-75TN176I	384	3.3	7.5	Lead-free TQFP	176	128	I
	LC4384V-10TN176I	384	3.3	10	Lead-free TQFP	176	128	I
LC4512V	LC4512V-5FTN256I	512	3.3	5	Lead-free ftBGA	256	208	I
	LC4512V-75FTN256I	512	3.3	7.5	Lead-free ftBGA	256	208	I
	LC4512V-10FTN256I	512	3.3	10	Lead-free ftBGA	256	208	I
	LC4512V-5FN256I ¹	512	3.3	5	Lead-free fpBGA	256	208	I
	LC4512V-75FN256I ¹	512	3.3	7.5	Lead-free fpBGA	256	208	I
	LC4512V-10FN256I ¹	512	3.3	10	Lead-free fpBGA	256	208	I
	LC4512V-5TN176I	512	3.3	5	Lead-free TQFP	176	128	I
	LC4512V-75TN176I	512	3.3	7.5	Lead-free TQFP	176	128	I
	LC4512V-10TN176I	512	3.3	10	Lead-free TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.